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Fairchild Semiconductor FDS4935BZ

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Distributor of Fairchild Semiconductor: Excellent Integrated System Limited Datasheet of FDS4935BZ - MOSFET 2P-CH 30V 6.9A 8-SOIC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

FAIRCHILD

SEMICONDUCTOR

FDS4935BZ

Dual 30 Volt P-Channel PowerTrench[®] MOSFET

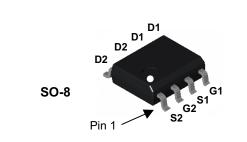
General Description

This P-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers, and battery chargers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{\text{DS}(\text{ON})}$ specifications.

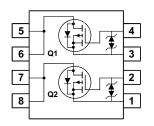
The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.





Features

- -6.9 A, -30 V. $R_{DS(ON)}$ = 22 m Ω @ V_{GS} = -10 V $R_{DS(ON)}$ = 35 m Ω @ V_{GS} = -4.5 V
- Extended V_{GSS} range (–25V) for battery applications
- ESD protection diode (note 3)
- High performance trench technology for extremely low R_{DS(ON)}
- High power and current handling capability



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS\}	Drain-Source Voltage		-30	V
V _{GS}	Gate-Source Voltage		<u>+</u> 25	V
I _D	Drain Current – Continuous	(Note 1a)	-6.9	A
	– Pulsed		-50	
P _D	Power Dissipation for Single Operation	(Note 1a)	1.6	W
		(Note 1b)	1.0	
		(Note 1c)	0.9	
T _J , T _{STG}	Operating and Storage Junction Temperate	ure Range	–55 to +150	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
R _{0JC}	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS4935BZ	FDS4935BZ	13"	12mm	2500 units

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FDS4935BZ Rev B1 (W)

FDS4935BZ

September 2006



$p_{D} = -250 mu$ A eferenced to 25°C $V_{GS} = 0 V$ $V_{DS} = 0 V$ -250 μ A eferenced to 25°C $p_{D} = -6.9 mu$ A $p_{D} = -5.3 mu$ A $p_{D} = -6.9 mu$ A $p_{D} = -6.9 mu$ A	-30	24 1.9 5 18 27.5	-1 <u>±</u> 10 -3 22	V mV/°C μΑ μΑ V mV/°C
eferenced to 25°C $V_{GS} = 0 V$ $V_{DS} = 0 V$ -250 μ A eferenced to 25°C $p_{D} = -6.9 A$ $p_{D} = -5.3 A$ $= -6.9A, T_{J} = 125°C$		-1.9 -5 18	<u>+</u> 10 _3	mV/°C μΑ μΑ V
eferenced to 25°C $V_{GS} = 0 V$ $V_{DS} = 0 V$ -250 μ A eferenced to 25°C $p_{D} = -6.9 A$ $p_{D} = -5.3 A$ $= -6.9A, T_{J} = 125°C$	-1	-1.9 -5 18	<u>+</u> 10 _3	μΑ μΑ V
$V_{GS} = 0 V$ $V_{DS} = 0 V$ $-250 \mu A$ deferenced to 25°C $p_{0} = -6.9 A$ $p_{0} = -5.3 A$ $= -6.9A, T_{J} = 125°C$		-1.9 -5 18	<u>+</u> 10 _3	μΑ μΑ V
$V_{DS} = 0 V$ = 250 µA efferenced to 25°C $p_{D} = -6.9 A$ $p_{D} = -5.3 A$ $= -6.9A, T_{J} = 125°C$	1	-5 18	<u>+</u> 10 _3	μA V
-250 μA eferenced to 25°C 0 = -6.9 A 0 = -5.3 A = -6.9A,TJ=125°C	-1	-5 18	-3	V
eferenced to 25°C 	_1	-5 18		
eferenced to 25°C 	_1	-5 18		
o = −6.9 A o = −5.3 A = −6.9A,TJ=125°C		18	22	mV/°C
5 = −5.3 A = −6.9A,Tյ=125°C		-	22	
= –6.9A,T _J =125°C		27.5		mΩ
			35	
= -6.9 A		26	34	
		22		S
	-			
′ _{GS} = 0 V,		1360		pF
		240		pF
		200		pF
_D = –1 A,		12	22	ns
$R_{GEN} = 6 \Omega$		13	23	ns
		68	108	ns
		38	61	ns
_o = –6.9 A,		29	40	nC
		16	23	nC
		4		nC
		7		nC
n Ratings				
urrent			-2.1	A
= -2.1 A (Note 2)		-0.8	-1.2	v
		24		ns
S (Note 2)		9		nC
	$R_{GEN} = 6 \Omega$ $p_{0} = -6.9 A,$ n Ratings urrent = -2.1 A (Note 2)	$R_{GEN} = 6 \Omega$	$P_{GEN} = 6 \Omega$ 13 68 38 $0 = -6.9 A,$ 29 16 4 7 n Ratings 1 $-2.1 A (Note 2)$ -0.8 24	$R_{GEN} = 6 \Omega$ $13 23 68 108 38 61 61 23 61 61 61 61 61 61 61 6$

FDS4935BZ

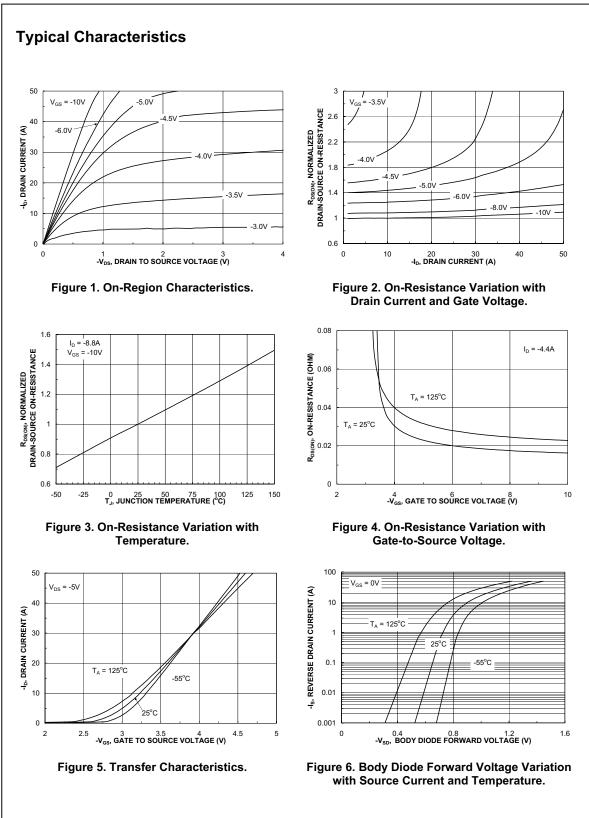


3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

FDS4935BZ Rev B1 (W)



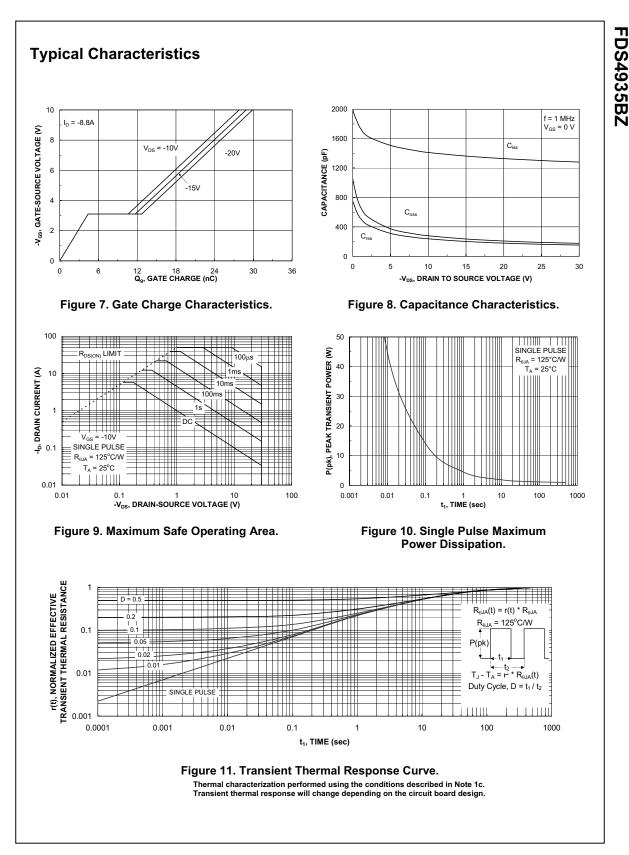
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